TOSHIBA SF1500EX26

TENTATIVE (UNDER DEVELOPMENT) TOSHIBA ALLOY-FREE THYRISTOR

SF1500EX26

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage : V_{DRM} $\}$ =2500V

Repetitive Peak Reverse Voltage: VRRM

 $: I_{T(AV)} = 1500A$ Average On-State Current

Turn-Off Time : $t_0 = 400 \mu s$ (Max.)

Critical Rate of Rise of On-State Current

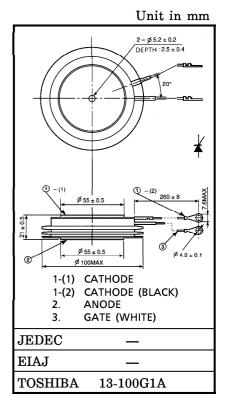
: $di/dt = 200A/\mu s$

Critical Rate of Rise of Off-State Voltage

 $: dv/dt = 500V/\mu s$

Weight : 630g

Flat Package



961001EAA1

The information contained herein is subject to change without notice.

TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.

The information contained herein is subject to change without notice.

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	V _{DRM} V _{RRM}	2500	V
Non-Repetitive Peak Reverse Voltage (Non-Repetitive $< 5 \text{ms}, T_j = 0 \sim 125 ^{\circ}\text{C}$)	V _{RSM}	2750	V
R.M.S On-State Current	I _T (RMS)	2355	A
Average On-State Current	I _T (AV)	1500	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	30000 (50Hz) 33000 (60Hz)	A
I ² t Limit Value	${ m I}^2{ m t}$	3125×10^{3}	${\sf A}^2{\sf s}$
Critical Rate of Rise of On-State Current (Note)	di/dt	200	A/μs
Peak Gate Power Dissipation	P_{GM}	30	W
Average Gate Power Dissipation	P _G (AV)	4	W
Peak Forward Gate Current	I_{GM}	6	Α
Peak Forward Gate Voltage	$v_{ m FGM}$	20	V
Peak Reverse Gate Voltage	v_{RGM}	5	V
Junction Temperature	T_{j}	-40~125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~125	$^{\circ}\mathrm{C}$
Mounting Force	_	19.6±2.0	kN

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	$I_{ m DRM}$ $I_{ m RRM}$	$V_{ m DRM} = V_{ m RRM} = { m Rated}$ $T_{ m j} = 125 { m ^{\circ}C}$		_	120	mA
Peak On-State Voltage	$ m V_{TM}$	$I_{TM} = 2500A, T_j = 25^{\circ}C$		_	1.75	V
Gate Trigger Voltage	v_{GT}	$T_{j} = -$ $T_{j} = 25$			4.5 3.5	V
Gate Trigger Current	I_{GT}	V_{D} =6V, R_{L} =6 Ω T_{j} =- T_{j} =25		_	600 450	mA
Gate Non-Trigger Voltage	$v_{ m GD}$	V _D =1/2 Rated, T _j =125°C		0.2	_	V
Gate Non-Trigger Current	I_{GD}			5	_	mA
Delay Time	$^{\mathrm{t}}\mathrm{d}$	V_D =1/2 Rated, T_j =25°C Gate Supply $(V_G$ =15V, R_G =8 Ω , t_r \leq 1 μ s)		_	5	μ s
Gate Turn-On Time	t_{gt}			_	10	μ s
Turn-Off Time	$\mathbf{t_q}$	I_{T} =1200A, V_{R} \ge 200V, dv/dt =25V/ μ s, T_{j} =115°C V_{DRM} =2300V		_	450	μ s
Holding Current	${ m I_H}$	$T_j=25$ °C, $R_L=6\Omega$			300	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	V _{DRM} =2/3 Rated, T _j =125°C Gate Open, Exponential Rise		500	_	V/μs
Thermal Resistance (Junction to Case)	$ m R_{th~(j-f)}$	DC		_	0.025	°C/W